

Product specifications

Part number	OCL (uH) minimum (1-2) & (4-3)	I rms. Amperes Max*	DCR (Ω) typ @ 20°C (1-2)	DCR (Ω) typ @ 20°C (4-3)	Leakage Inductance (uH) typ	Interwinding Capacitance (pF) typ
CMS1-1-R	4.5	7.00	0.0027	0.0027	0.05	2.0
CMS1-2-R	8	5.70	0.0040	0.0040	0.09	2.1
CMS1-3-R	12.6	4.10	0.077	0.077	0.14	2.2
CMS1-4-R	18	3.80	0.0089	0.0089	0.20	2.3
CMS1-5-R	25	3.60	0.0100	0.0100	0.28	2.4
CMS1-6-R	32.8	3.10	0.0138	0.0138	0.36	2.5
CMS1-7-R	41.5	2.60	0.019	0.019	0.45	2.6
CMS1-8-R	51.2	2.20	0.026	0.026	0.056	2.7
CMS1-9-R	62	1.90	0.035	0.035	0.68	2.7
CMS1-10-R	73.7	1.65	0.048	0.048	0.81	2.8
CMS1-11-R	100	1.35	0.070	0.070	1.10	3.9
CMS1-12-R	131	1.15	0.100	0.100	1.45	3.0
CMS1-13-R	166	1.00	0.138	0.138	1.83	3.1
CMS1-14-R	205	0.85	0.186	0.186	2.25	3.2
CMS2-0-R	14	6.00	0.004	0.004	0.13	1.7
CMS2-1-R	25	5.35	0.005	0.005	0.22	2.0
CMS2-2-R	40	4.40	0.008	0.008	0.34	2.3
CMS2-3-R	57	3.60	0.012	0.012	0.47	2.5
CMS2-4-R	102	2.80	0.019	0.019	0.80	2.8
CMS2-5-R	160	2.30	0.029	0.029	1.25	3.1
CMS2-6-R	230	1.85	0.044	0.044	1.75	3.4
CMS2-7-R	270	1.60	0.060	0.060	2.00	3.6
CMS2-8-R	360	1.35	0.084	0.084	2.60	3.9
CMS2-9-R	460	1.10	0.120	0.120	3.30	4.3
CMS2-10-R	575	0.94	0.170	0.170	4.00	4.3
CMS2-11-R	700	0.80	0.230	0.230	5.00	4.6
CMS2-12-R	915	0.67	0.330	0.330	6.30	4.9
CMS2-13-R	1070	0.58	0.440	0.440	7.30	5.1
CMS2-14-R	1340	0.50	0.620	0.620	9.00	5.4
CMS3-1-R	28	5.70	0.005	0.005	0.31	2.80
CMS3-2-R	45	5.10	0.006	0.006	0.46	3.05
CMS3-3-R	64	4.75	0.007	0.007	0.64	3.30
CMS3-4-R	88	3.95	0.010	0.010	0.85	3.50
CMS3-5-R	146	3.10	0.017	0.017	1.30	3.70
CMS3-6-R	217	2.85	0.020	0.020	1.90	3.90
CMS3-7-R	258	2.45	0.027	0.027	2.20	4.15
CMS3-8-R	350	2.00	0.040	0.040	3.00	4.40
CMS3-9-R	400	1.70	0.053	0.053	3.30	4.65
CMS3-10-R	518	1.45	0.076	0.076	4.20	4.85
CMS3-11-R	648	1.20	0.107	0.107	5.10	5.10
CMS3-12-R	790	1.05	0.145	0.145	6.10	5.35
CMS3-13-R	1030	0.88	0.210	0.210	7.80	5.55
CMS3-14-R	1310	0.75	0.300	0.300	9.60	5.80

Definitions:

OCL = Open Circuit Inductance

DCR = Direct Current Resistance

I_{rms} = rms current for approx. a 40°C temperature rise at an ambient temperature of 85°C.

*Operating Temperature: 160°C Max. Inductance values are sustained up to 160°C.

Electrical Characteristics:

OCL (1-2) 0.10Vrms, 100kHz, 0.0Adc: (See Chart)

OCL (4-3) 0.10Vrms, 100kHz, 0.0Adc: (See Chart)

DCR (1-2) typ @ 20°C: (See Chart)

DCR (4-3) typ @ 20°C: (See Chart)

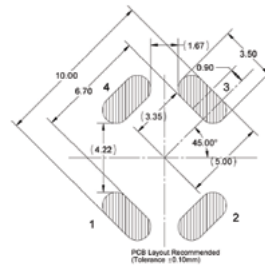
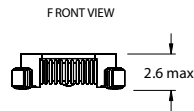
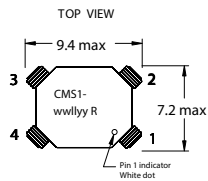
Hipot rating: winding to winding: 300Vdc min. for 1 second.

Turns Ratio: (1-2):(4-3) 1:1

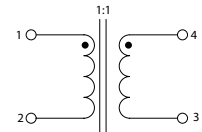
Dimensions—mm

CMS1

RECOMMENDED PCB LAYOUT

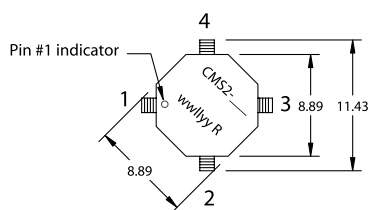


SCHEMATIC

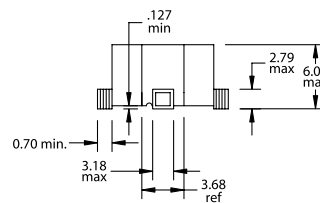


CMS2

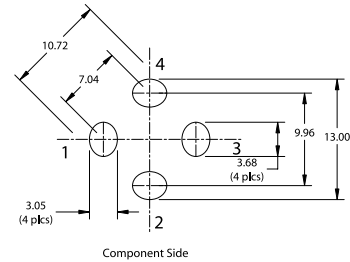
TOP VIEW



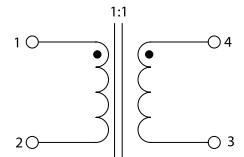
FRONT VIEW



RECOMMENDED PCB LAYOUT

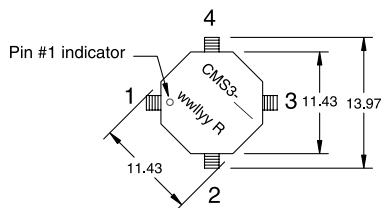


SCHEMATIC

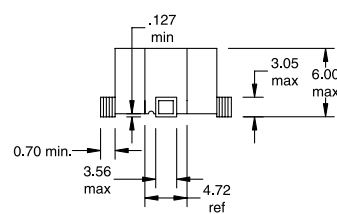


CMS3

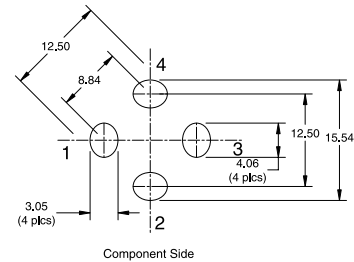
TOP VIEW



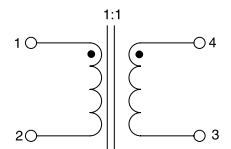
FRONT VIEW



RECOMMENDED PCB LAYOUT



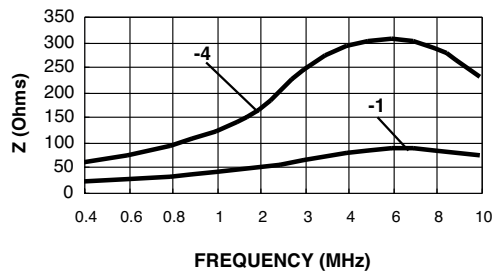
SCHEMATIC



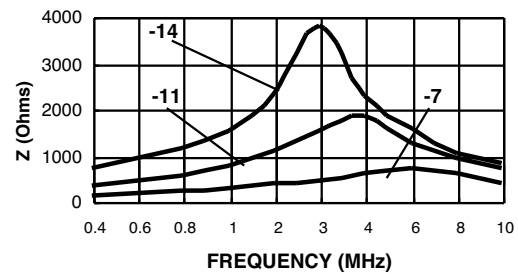
wwlyy = Date code R = Revision level

Impedance Curves

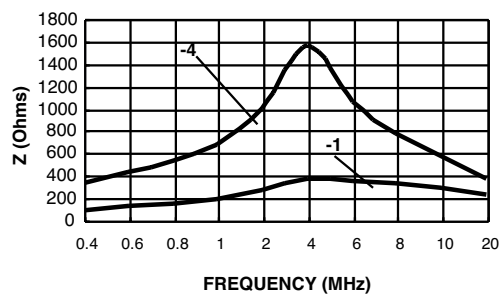
Impedance CMS1-1 & 4



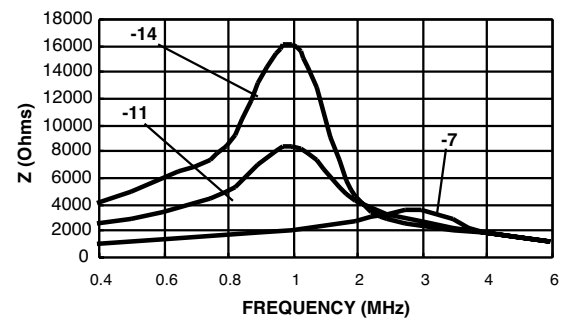
Impedance CMS1 - 7,11, & 14



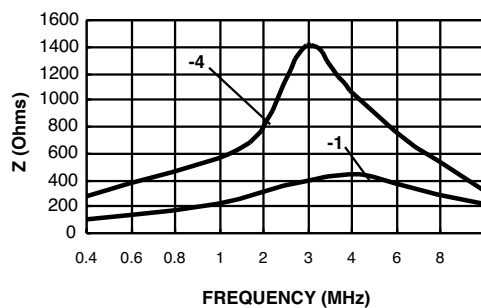
Impedance CMS2 - 1 & 4



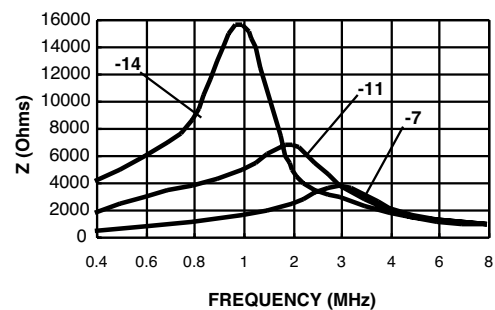
Impedance CMS2 - 7,11, & 14



Impedance CMS3 - 1 & 4



Impedance CMS3 - 7,11, & 14



Solder reflow profile

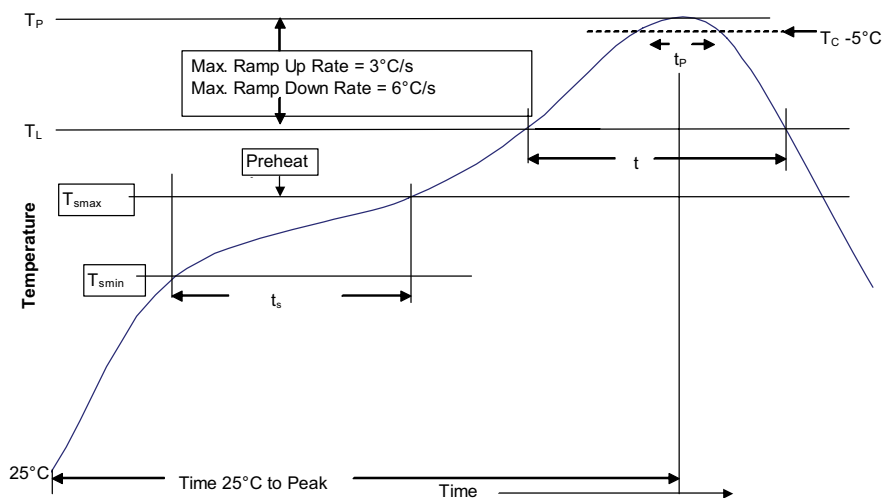


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Average ramp up rate T_{smax} to T_P	3 °C/ second Max.	3 °C/ second Max.
Liquidous temperature (T_L)	183 °C	217 °C
Time at liquidous (t_L)	60-150 seconds	60-150 seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_P)** within 5 °C of the specified classification temperature (T_C)	20 seconds**	30 seconds**
Average ramp-down rate (T_P to T_{smax})	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_P) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

Eaton
Electronics Division
1000 Eaton Boulevard
Cleveland, OH 44122
United States
www.eaton.com/electronics

© 2018 Eaton
All Rights Reserved
Printed in USA
Publication No. 4313 PCN18009
September 2018



Eaton is a registered trademark.

All other trademarks are property of their respective owners.